171825-4 - ACTIVE

TE Internal #: 171825-4 PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 2.5 mm [. 098 in] Centerline, Partially Shrouded, Tin, Through Hole - Solder, Signal, Natural

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Connectors > PCB Connectors > PCB Headers & Receptacles



Connector System: Wire-to-Board

Number of Positions: 4

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]

PCB Mount Orientation: Vertical

Features

Product Type Features



Connector System	Wire-to-Board
Header Type	Partially Shrouded
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	4
Number of Rows	1
PCB Mount Orientation	Vertical
Body Features	
Primary Product Color	Natural
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]
Contact Mating Area Plating Material Thickness	.8 μm[31.496 μin]
Contact Mating Area Plating Material	Tin

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Termination FeaturesSquare Termination Post & Tail Dimension.64 mm[.025 in]Termination Method to Printed Circuit BoardThrough Hole - SolderMechanical AttachmentMating Alignment TypePolarizationMating RetentionWithConnector Mounting TypeBoard MountMating AlignmentWithoutPCB Mount AlignmentWithoutPCB Mount RetentionWithoutHousing FeaturesHousing MaterialIncomplete Index (Pitch)Same_O28 in]
Termination Method to Printed Circuit BoardThrough Hole - SolderMechanical AttachmentPolarizationMating Alignment TypePolarizationMating RetentionWithConnector Mounting TypeBoard MountMating AlignmentWithoutPCB Mount AlignmentWithoutPCB Mount RetentionWithoutHousing FeaturesBrass
Mechanical AttachmentMating Alignment TypePolarizationMating RetentionWithConnector Mounting TypeBoard MountMating AlignmentWithPCB Mount AlignmentWithoutPCB Mount RetentionWithoutHousing MaterialBrass
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PCB Mount AlignmentWithoutPCB Mount RetentionWithoutHousing FeaturesWithoutHousing MaterialBrass
PCB Mount Retention Without Housing Features Without
Housing Material Brass
Housing Material Brass
Centerline (Pitch) 2.5 mm[.098 in]
Usage Conditions
Operating Temperature Range -20 – 95 °C[-4 – 203 °F]
Operation/Application
Circuit Application Signal
Industry Standards
UL Flammability Rating UL 94V-0
Packaging Features
Packaging Type Bag
Product Compliance
For compliance documentation, visit the product page on TE.com>
EU RoHS Directive 2011/65/EU Compliant
EU ELV Directive 2000/53/EC Compliant
China RoHS 2 Directive MIIT Order No 32, 2016 No Restricted Materials Above Thresh
EU REACH Regulation (EC) No. 1907/2006 Current ECHA Candidate List: JUNE 2 (224) Candidate List Declared Against: JUN 2022 (224) Does not contain REACH SVHC
Does not contain REACH SVHC

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Halogen Content

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

Compatible Parts



Documents

Product Drawings TYPE V EIS CONNECTOR 4P ASSY

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_171825-4_Y2.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_171825-4_Y2.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_171825-4_Y2.3d_stp.zip

English

By downloading the CAD file I accept and agree to the Terms and Conditions of use

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Datasheets & Catalog Pages 1-1773972-5_EIS_Connectors_Brochure

English

Product Specifications

Crimping of AMP El Series Connector Contacts

Japanese

Application Specification

Japanese

Product Environmental Compliance MD_171825-4_052120181012_dmtec

English

MD_171825-4_052120181012_dmtec

English

Agency Approvals Agency Approval Document

English